

## PATENT ABSTRACTS OF JAPAN

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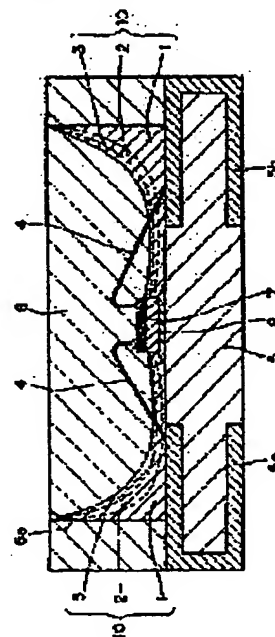
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## (54) LIGHT EMITTING ELEMENT AND ITS MANUFACTURING METHOD

(57)Abstract:

**PROBLEM TO BE SOLVED:** To provide a light emitting element which can obtain stable high luminous efficiency for a long period.

**SOLUTION:** In this light emitting element, a semiconductor LED chip is provided in the recess of a package and the recess is filled up with a light-transmissive resin so as to cover the LED chip. A light scattering layer in which an inorganic material that scatters the light from a semiconductor LED and which has a glass layer in which the inorganic material is scattered and a resin layer formed on the glass layer is provided between the recess and the light-transmissive resin.



## LEGAL STATUS

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